

LINEAR TECHNOLOGY MATERIALS DECLARATION

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(Engineering Calculation)

QFN 4mm X 5mm Exp. Pad

(printed on: 2020-07-11 18:24:28)

TOTAL MASS (g) : 0.049208

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.001728	1000000	35116.0898438		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.019997	975000	406375.28125		
		Iron (Fe)	7439-89-6	0.000492	24000	9998.33203125		
		Phosphorus (P)	7723-14-0	0.000006	300	121.930885315		
		Zinc (Zn)	7440-66-6	0.000014	700	284.505371094		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
Lead Frame Total:				0.020509	1000000	416780.09375		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.000227	1000000	4617.27783203		
		External Plating Total:				0.000227	1000000	4617.27783203
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000498	1000000	10120.2626953		
Internal Plating Total:				0.000498	1000000	10120.2626953		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000822	750000	16704.5292969		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000274	250000	5568.17626953		
Die Attach Total:				0.001096	1000000	22272.7050781		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.003244	130000	65923.9609375		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.021457	860000	436045.125		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.000250	10000	5080.45361328		
		Encapsulation Total:				0.024951	1000000	507049.5625
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000199	1000000	4044.04052734		
					TOTAL MASS (g) :	0.049208		